

# Final Technical Report: Atmospheric Energy Harvester Concept & Circuit Modeling

**Author:** \_\_\_\_\_ [Your \_\_\_\_\_ Name]  
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## Abstract

This report presents the conceptual design, modeling, and preliminary simulation work for a hybrid atmospheric energy harvester. The device aims to capture weak electric currents from the atmosphere—through a resonant electrode structure—and convert them via a low-noise transimpedance amplifier into stored energy for ultra-low-power devices. We discuss the architecture, SPICE pseudo-models, circuit nets, simulation expectations, risks, and recommendations for future prototyping.

**Keywords:** atmospheric energy harvesting, transimpedance amplifier, SPICE modeling, low input current, electrode design

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## 1. Introduction & Objectives

We explored a device that passively harvests the Earth-atmospheric electric potential through a resonant electrode structure to generate micro- or nano-level energy. This report documents:

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- The theory grounding the concept
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- Circuit architecture and amplifier design
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- Pseudo-SPICE modeling for LMC6001 with experimental parameter estimates
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- Simulation templates (netlists) and directive settings
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- Performance expectations and bottleneck analysis
- 
- Recommendations for the next phases of prototype development

## 2. Technical Background & Reference Data

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- **LMC6001 Amplifier:** According to its datasheet, the input bias current is up to  $\sim 25$  fA at  $25^\circ\text{C}$ ; under adverse conditions can increase toward  $\sim 2$  pA.
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- Noise, offset, and drift features from the datasheet inform the model's parameters.
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- Atmospheric electric fields are often  $\sim 100$  V/m under calm conditions; air conductivity is extremely low, meaning harvested currents over electrode areas of  $\sim 1$  m<sup>2</sup> are on the order of pico- to nanoamperes.

### 3. System Architecture and Circuit Topology

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- The core signal path: **Electrode** → **TIA (inverting input)** → **feedback network** → **output** → **rectifier / storage**
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- A **Transimpedance Amplifier (TIA)** is chosen to convert minute currents to measurable voltages, using  $R_{fR\_fRf}$  (feedback resistor) and  $C_{fC\_fCf}$  (compensation capacitor).
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- To suppress leakage, **guard rings / driven shields** surround high-impedance lines and connections.
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- The design anticipates integration of a rectification stage, storage (supercapacitors / battery), and protection circuits.

### 4. Pseudo-SPICE Models and Netlist Templates

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- We defined a .SUBCKT model for LMC6001 with example parameters:
  - Input bias currents  $\sim 10\text{--}25$  fA
  - Offset voltage  $\sim 1$   $\mu$ V
  - Nonlinear leakage controlled in the model
  - Gain stage with amplification factor  $\sim 1 \times 10^6$
- Output stage with approximate output resistance
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- Netlist template ensures that the TIA stage, current source, feedback elements, and amplifier subcircuit can be simulated together.

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- SPICE options such as `abstol`, `gmin`, and `reitol` configured for low-current regimes to avoid internal numeric shunting.

## 5. Simulation Expectations and Estimates

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- With a source current of  $\sim 10\text{ pA}$  and  $R_f = 1\text{ G}\Omega$ , the output voltage could reach tens of millivolts (in ideal conditions).
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- At lower current levels (femto- to picoampere range), signal is extremely vulnerable to noise, offset drift, and leakage.
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- Parasitic elements (PCB leakage, stray capacitances, amplifier input leakage) will significantly reduce effective signal.
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- Reaching milliwatt power levels demands extraordinary enhancements: vast electrode area, ultra-low loss circuitry, extremely low noise design, and perhaps active gain stages.

## 6. Risks, Limitations, and Critical Factors

Factor	Importance	Mitigation Strategy
Surface leakage and parasitics	Even tiny leakage paths can nullify signal	Guard rings, clean surfaces, ultra-high

		insulation
Amp lifier nois e & offse t	At very low curre nts, nois e may domi nate	Sele ct ultra -low nois e devi ces, filter ing, calib ratio n
Stabi lity / oscil latio n	High gain + react ive com pone nts can caus e insta bilit y	Prop er com pens ation (cho ose CfC _fCf caref ully) , phas e marg in chec ks
Para sitic capa citan ce / indu ctan ce	Dist orts sign al coup ling and limit s band widt	Care ful layo ut, shiel ding, mini mal trace lengt hs

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## 7. Recommendations & Roadmap

- 1.
2. **Run simulations** using the provided netlist / model, sweeping source current, feedback parameters, leakage values to analyze sensitivity.
- 3.
4. **Build a physical prototype** of the TIA stage with guard ring, high-precision components, and shielding; measure input currents, output, offset, noise.
- 5.
6. **Calibrate the model** using real experimental results— adjust leakage, offset, gain, parasitic parameters.
- 7.
8. Add **parasitic elements** into simulation: electrode capacitance, PCB leakage, stray coupling.
- 9.
10. Explore electrode materials (e.g. graphene + Au coatings, nanostructures) to maximize harvesting efficacy.
- 11.
12. Optimize compensation networks (CfC\_fCf), stability margins, possibly multi-stage amplification.

- 13.
14. Gradually **scale up** electrode area, integrate protective measures, and test in real atmospheric conditions.

## 8. References

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## 9. Appendices

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- Appendix A: Netlist template
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- Appendix B: Pseudo-SUBCKT model code
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- Appendix C: Parameter definitions and units
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- Appendix D: Additional simulation configuration notes